

	P	RODUCT/PRO	CESS CHANGE NOTICE (PCN)	
PCN #: TB17(Product Affected Date Effective:		765NLGI8	MEANS OF DISTINGUISHING CHANGED DEVICES: Product Mark New orderable part numbers Back Mark Date Code Other	
Contact:	TPD Clock Team		Attachment: Yes No	
E-mail:	clocks@idt.com	l.	Samples: Samples are available now.	
 Wafer Fabrication Process Assembly Process Equipment The change improves device ro Material capacitance on the system is be customer's on-board capacitance Manufacturing Site Data Sheet Other - Programming There are no AC or DC changed The current version of this devi 			customers that a minor programming change was made to the affected part numb e robustness for oscillation startup. The reason for this change is that the current 1 s beyond the silicon design target. The load capacitiance is a combined value of tance and device's in-circuit programmable capacitance. Reducing the programme m 8pF to 4.5pF, will result in reducing the total load capacitance. This reduction ptimal value of customer crystal specification and puts the silicon oscillator load nges related to this change. device will be discontinued as of the effective date on this notice. The new ordera 01B935NLGI and 5P49V5901B935NLGI8.	load ed in back
There is no chang			e change based on device characterization result. and ATE testing.	
IDT records indi to grant approva it will be assume IDT reserves the	cate that you requi l or request additioned that this change right to ship eithe	nal information. If IDT doe is acceptable. r version manufactured after	s change. Please use the acknowledgement below or E-Mail not receive acknowledgement within 30 days of this notice the process change effective date until the inventory be discontinued after the effective date.	
Customer:		[Approval for shipments prior to effective date.	
Name/Date:		H	-Mail Address:	
Title:		I	hone # /Fax #:	
CUSTOMER C	OMMENTS:			
IDT ACKNOW	LEDGMENT OF	RECEIPT:		
RECD. BY:			DATE:	